

# LOCTITE ABLESTIK ATB 130

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## PRODUCT DESCRIPTION

LOCTITE ABLESTIK ATB 130 provides the following product characteristics:

<b>Technology</b>	Rubberized Epoxy
<b>Appearance</b>	Transparent
<b>Cure</b>	Heat cure
<b>Product Benefits</b>	<ul style="list-style-type: none"> <li>• Excellent wettability</li> <li>• Easy die pick up</li> <li>• One step lamination</li> <li>• Excellent package reliability</li> </ul>
<b>Application</b>	Die attach
<b>Filler Type</b>	Silica
<b>Typical Package Application</b>	Die to die stack
<b>Carrier Type</b>	Polyolefin
<b>Adhesive Thickness</b> $\mu\text{m}$	30 $\mu\text{m}$
<b>Carrier Film Thickness</b> $\mu\text{m}$	85 $\mu\text{m}$
<b>Wafer Size</b>	8 and 12

LOCTITE ABLESTIK ATB 130 adhesive film is formulated for use in wafer lamination processes. It combines process ease with the proven reliability of a hybrid chemistry-based die attach material. LOCTITE ABLESTIK ATB 130 is pre-applied to a modified dicing tape for easy pick-up and one step lamination.

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Work Life @ 25°C, days	30
Shelf Life @ 5°C (from date of manufacture), days	270

## TYPICAL PROCESS DATA

### Wafer Backside Lamination

Temperature, °C	70
Pressure, psi	30
Taping Duration, ft/ minute	1

### Chip Attach

Temperature, °C	100 to 120
Pressure, kg-f	0.5 to 2
Attach Duration, second	1

## TYPICAL CURING PERFORMANCE

### Cure Schedule

30 minute ramp to 100°C; 30 minutes @ 100°C + 30minute ramp from 100°C to 125°C; 30 minutes @ 125°C

### Alternate Cure Schedule

30 minute ramp to 120°C + 2 hours @ 120°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

## TYPICAL PROPERTIES OF CURED MATERIAL

### Physical Properties

Coefficient of Thermal Expansion, , TMA expansion mode:

Below Tg, ppm/°C	46
Above Tg, ppm/°C	139

Glass Transition Temperature, TMA penetration mode, 90 °C

Tensile Modulus, DMTA :

@ -65 °C	N/mm <sup>2</sup>	3,170
	(psi)	(459,480)
@ 25 °C	N/mm <sup>2</sup>	1,170
	(psi)	(169,110)
@ 150 °C	N/mm <sup>2</sup>	12.5
	(psi)	(1,810)
@ 200 °C	N/mm <sup>2</sup>	7.3
	(psi)	(1,060)
@ 250 °C	N/mm <sup>2</sup>	8.6
	(psi)	(1,250)

Extractable Ionic Content, :

Chloride (Cl-)	<10
Sodium (Na+)	<10
Potassium (K+)	<10

Weight Loss @ 300°C, %

1

Moisture Absorption @ Saturation, after 85°C/85% RH 1.5 exposure, %

## TYPICAL PERFORMANCE OF CURED MATERIAL

Die Shear Strength:

2.5 x 2.5 mm Si die frontside, kg-f:

@ 25°C	15
@ 260°C	2

## GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

### Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$   
 $\text{kV/mm} \times 25.4 = \text{V/mil}$   
 $\text{mm} / 25.4 = \text{inches}$   
 $\text{N} \times 0.225 = \text{lb/F}$   
 $\text{N/mm} \times 5.71 = \text{lb/in}$   
 $\text{psi} \times 145 = \text{N/mm}^2$   
 $\text{MPa} = \text{N/mm}^2$   
 $\text{N} \cdot \text{m} \times 8.851 = \text{lb} \cdot \text{in}$   
 $\text{N} \cdot \text{m} \times 0.738 = \text{lb} \cdot \text{ft}$   
 $\text{N} \cdot \text{mm} \times 0.142 = \text{oz} \cdot \text{in}$   
 $\text{mPa} \cdot \text{s} = \text{cP}$

**DIRECTIONS FOR USE**

1. Ensure all surfaces to be bonded are free from surface contamination.
2. Adhesive must be completely used within the product's recommended work life.
3. Remove the tape reel from the moisture-resistant package and load into the tape application machine.
4. Store unused adhesive film in the original sealed moisture-resistant package until needed.

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**STORAGE:**

These adhesive film should be stored at 0 to 5°C, in its original moisture resistant packaging. Partially used reels should be stored under dry conditions at 0 to 5°C.

To minimize moisture absorption, we recommend storing the adhesive film in the sealed moisture-resistant package until needed.

**Optimal Storage: 5°C. Storage below 5°C or greater than 5°C can adversely affect product properties.**

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Reference 0.1